

What is claimed is:

1. A method for manufacturing a low-resistance ITO film
5 comprising a step of:

depositing an ITO film on a crystalline substrate having
a temperature of 500-1000°C by a pulsed laser vapor deposition
method.

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2. A method for manufacturing a low-resistance ITO film
according to claim 1, wherein a crystal orientation of a surface
of said crystalline substrate is receptive to a crystal
structure of In_2O_3 .

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3. A method for manufacturing a low-resistance ITO film
according to claim 1, wherein said crystalline substrate is one
of a YSZ single crystal substrate, a substrate on which a c-
20 axis oriented ZnO thin film is formed, a sapphire substrate, a
SiC single crystal substrate and a silicon single crystal
substrate.

25 4. A method for manufacturing a low-resistance ITO film
according to claim 3, wherein said crystalline substrate is a
YSZ single crystal substrate super-flattened to an atomic order
by a heat treatment in the range of 1200-1500°C.

5. A method for manufacturing a low-resistance ITO film according to claim 2, wherein said ITO film is deposited in heteroepitaxial growth.

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6. A method for manufacturing a low-resistance ITO film according to claim 1, wherein indium oxide is deposited lattice by lattice in an atomic layer growth mode at a low deposition rate on said substrate.

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7. A method for manufacturing a low-resistance ITO film according to claim 1, wherein said ITO film has a resistance of less than $1 \times 10^{-4} \Omega\text{cm}$.

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8. A method for manufacturing a low-resistance ITO film according to claim 1, wherein said ITO film has a SnO₂ content of 2.8 - 10.5 mol%.

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9. A method for manufacturing a low-resistance ITO film comprising a step of:

depositing ITO film on a crystalline substrate by one of
25 a low-voltage sputtering, an oxygen cluster beam deposition, a chemical vapor deposition, a metal organic chemical vapor deposition, a metal organic chemical vapor deposition - atomic layer deposition, and a molecule beam epitaxy.

10. A method for manufacturing a low-resistance ITO film according to claim 9, wherein said ITO film is deposited on a crystalline substrate having a temperature of 500-1000°C.

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11. A method for manufacturing a low-resistance ITO film according to claim 9, wherein a crystal orientation of a surface of said crystalline substrate is receptive to a crystal structure of In_2O_3 .

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12. A method for manufacturing a low-resistance ITO film according to claim 11, wherein said crystalline substrate is one of a YSZ single crystal substrate, a substrate on which a c-axis oriented ZnO thin film is formed, a sapphire substrate, a SiC single crystal substrate and a silicon single crystal substrate.

20 13. A method for manufacturing a low-resistance ITO film according to claim 12, wherein said crystalline substrate is a YSZ single crystal substrate super-flattened to an atomic order by a heat treatment in the range of 1200-1500°C.

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14. A method for manufacturing a low-resistance ITO film according to claim 11, wherein said ITO film is deposited in heteroepitaxial growth.

15. A method for manufacturing a low-resistance ITO film according to claim 9, wherein said ITO film has a resistivity lower than $1 \times 10^{-4} \Omega\text{cm}$.

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16. A method for manufacturing a low-resistance ITO film according to claim 9, wherein said ITO film has a SnO_2 content of 2.8 - 10.5 mol%.

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17. A low-resistance ITO film having a resistivity lower than $1 \times 10^{-4} \Omega\text{cm}$ and a Sn dopant activity defined as [(carrier density(cm^{-3}))/Sn density in said ITO film (number of Sn/cm^3) \times 100] greater than 80%.

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18. A substrate having a ITO film deposited thereon comprising:

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a crystalline substrate, and
an ITO film deposited on said crystalline substrate having a temperature of 500-1000°C by a pulsed laser deposition.

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19. A substrate having a ITO film deposited thereon comprising:
a crystalline substrate, and
an ITO film deposited by one of a low-voltage sputtering, an oxygen cluster beam deposition, a chemical vapor deposition,

a metal organic chemical vapor deposition, a metal organic chemical vapor deposition - atomic layer deposition, and a molecule beam epitaxy.

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20. A substrate having a ITO film deposited thereon according to claim 18, wherein a patterning is formed in said ITO film.

10 21. A substrate having a ITO film deposited thereon according to claim 19, wherein a patterning is formed in said ITO film.

22. A substrate having a low-resistance ITO film deposited
15 thereon comprising:

a crystalline substrate, and
an ITO film having a Sn dopant activity defined as
 $[(\text{carrier density } (\text{cm}^{-3}) / \text{Sn density in said ITO film (number of Sn/cm}^3) \times 100]$ greater than 80%.

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23. A substrate having a low-resistance ITO film deposited thereon according to claim 22, wherein said ITO film has a resistivity lower than $1 \times 10^{-4} \Omega \text{cm}$.

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24. A substrate having a low-resistance ITO film deposited thereon according to claim 22, wherein a patterning is formed

in said ITO film.

25. A substrate having a low-resistance ITO film deposited
5 thereon according to claim 23, wherein a patterning is formed
in said ITO film.

A handwritten signature consisting of stylized, cursive letters. The signature appears to begin with 'H' or 'A', followed by 'D', 'A', 'T', 'O', 'R', and 'S'. There are several loops and connecting strokes throughout the signature.